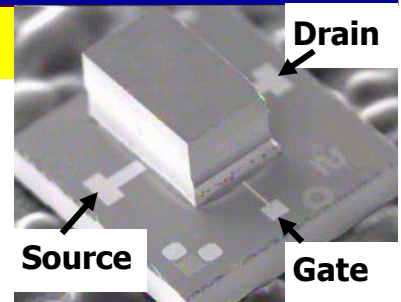




SPST, High Power RF-MEMS Switch, DC to 12 GHz

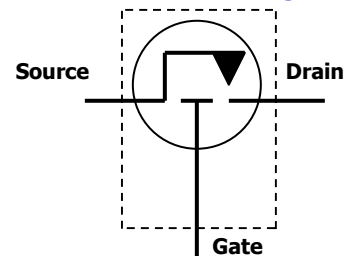


RMSW100HP™

Features

- Long Life at High Power (typical >10 billion cycles @ 36 dBm cold-switched, >1 billion cycles @ 40 dBm cold-switched)
- Low Insertion Loss (0.16 dB typical @ 2.4 GHz)
- High Isolation (23 dB typical @ 2.4 GHz)
- Near Zero Harmonic Distortion
- No Quiescent Power Dissipation
- Hermetically sealed die designed for die-attach and wire-bond to board. Please contact us for other packaging options.

Functional Block Diagram



Description

The RMSW100HP™ is a Single Pole Single Throw (SPST) Reflective RF Switch utilizing Radant's break-through MEMS technology that delivers high linearity, high isolation and low insertion loss in a chip-scale package configuration.

This device is ideally suited for use in many applications such as RF and microwave multi-throw switching, radar beam steering antennas, phase shifters, RF test instrumentation, ATE, cellular, and broadband wireless access.

Typical Device Specifications

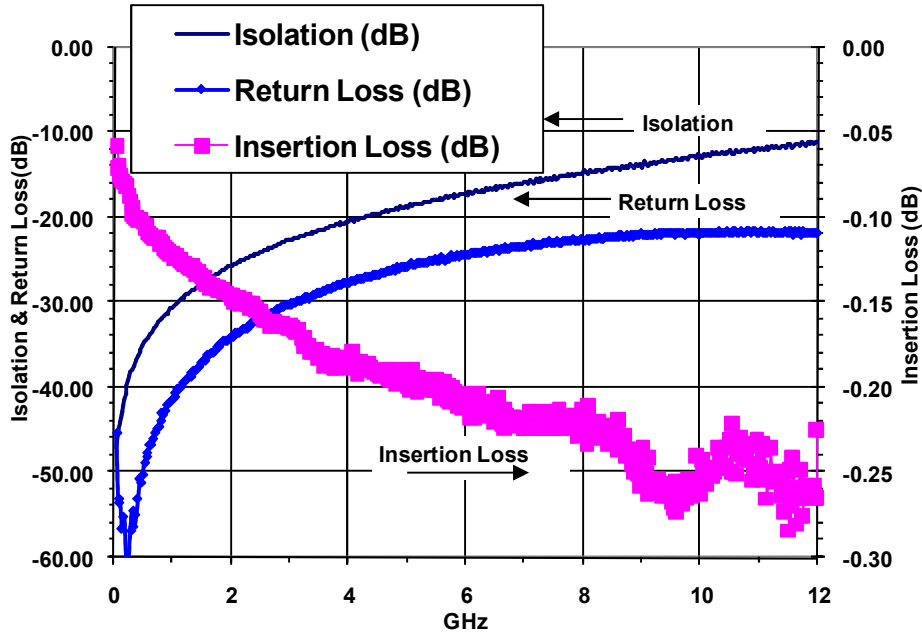
Insertion Loss DC 2 GHz 4 GHz 10 GHz	< 2 Ω < 0.17 dB < 0.20 dB < 0.28 dB	Lifecycle Cold-switched, 36dBm Cold-switched, 40 dBm Cold-switched, 42 dBm Hot-switched, -20 dBm Hot-switched, -10 dBm Hot-switched, 20 dBm	> 10 ¹¹ cycles > 10 ⁹ cycles > 10 ³ cycles > 10 ¹¹ cycles > 10 ⁹ cycles > 10 ³ cycles
Isolation DC 2 GHz 4 GHz 10 GHz	> 1 GΩ > 23 dB > 20 dB > 11 dB	Control Gate-Source Voltage (on) Gate-Source Voltage (off) Control Power, steady-state Control Power, 1 KHz cycle rate	+/- 90 V 0 V < 1 nW < 2 μW
Return Loss 2 GHz 4 GHz 10 GHz	< -30 dB < -24 dB < -20 dB	Switching speed On Off	< 10 μs < 2 μs
Input IP3 (Two-tone inputs 900 MHz and 901 MHz up to +5 dBm)	> 65 dBm	Operating temperature Maximum Minimum	85 °C -40 °C
		Storage temperature Maximum Minimum	150 °C -55 °C

Notes:

1. All RF measurements were made in a 50 Ω system.
2. Measurements include bond-wires from die to test-board.

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Typical Performance

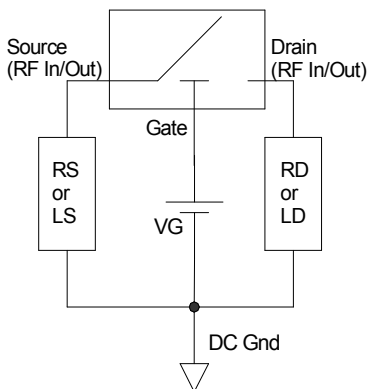


* Measurement results include bond wires

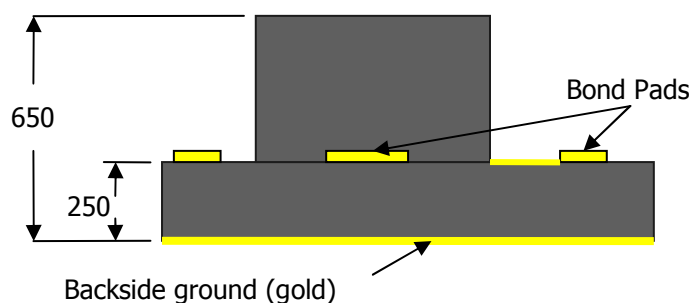
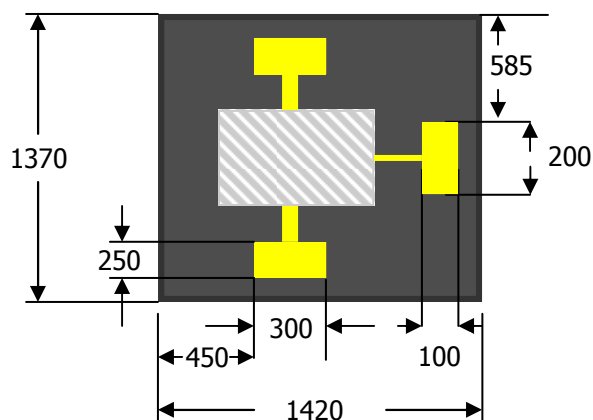
Absolute Maximum Ratings

Maximum Temperature (10 seconds)	290 °C
(120 seconds)	250 °C
Maximum Voltage, Gate-Source	+/- 110 V
Maximum Voltage, Drain-Source	+/- 100 V

Recommended Application



1. Resistors RS and RD (40 KΩ-100 KΩ) or inductors LS and LD should be used to provide a path to DC Ground from Source and Drain.
2. VG may be of either polarity.
3. VG rise-time should be at least 10 μs for optimal lifetime.
4. Please refer to "Application Note for Test and Handling of SPST RF-MEMS Switches" for more information. Contact us for driver solutions.

Nominal Device Dimensions

Dimensions are in micrometers.
Please contact us for a footprint in .gds or .dxf format.

Static sensitivity

This device has an ESD (HBM) sensitivity of 100 V. Use proper ESD precautions when handling. Please refer to "Application Note for Test and Handling of SPST RF-MEMS Switches" for more information.

Die Assembly

The gold backside-metallization on the die is designed to be mounted with electrically conductive silver epoxy, or with a lower temperature solder which does not consume gold. Bond pads on the die are made of gold. Ball-bonds should be utilized to attach gold or Aluminum 1 mil wires. Please refer to "Application Note for Test and Handling of SPST RF-MEMS Switches" for more information.